

DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

Docket No. YOR920030173US1

As below named inventors, we hereby declare that:

Our residences, post office addresses and citizenships are as stated below next to our respective names.

We believe we are the original and first joint inventors of the subject matter which is claimed and for which a patent is sought on the invention entitled:

IMPROVED CHEMICAL PLANARIZATION PERFORMANCE FOR COPPER/LOW-K INTERCONNECT STRUCTURES

the specification of which

(check one) XXX is attached hereto.

_____ was filed on _____ as Application Serial No. _____ and was amended on _____ (if applicable).

We hereby state that we have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

We acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to us to be material to the patentability of this application as defined in Title 37, Code of Federal Regulations, §1.56.

We hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate(s) listed below and have also identified below any foreign application(s) for patent or inventor's certificate(s) having a filing date before that of the application on which priority is claimed:

<u>Prior Foreign Application(s)</u>			<u>Priority Claimed</u>
_____ (Number)	_____ (Country)	_____ (Day/Mon/Year Filed)	___ Yes ___ No
_____ (Number)	_____ (Country)	_____ (Day/Mon/Year Filed)	___ Yes ___ No
_____ (Number)	_____ (Country)	_____ (Day/Mon/Year Filed)	___ Yes ___ No

We hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, we acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

FULL NAME OF INVENTOR	LAST NAME NICHOLSON	FIRST NAME LEE	MIDDLE NAME M
RESIDENCE & CITIZENSHIP	CITY KATONAH	STATE OR COUNTRY NEW YORK	CITIZENSHIP UK
POST OFFICE ADDRESS	P.O. ADDRESS 39 HUNTVILLE ROAD	CITY & STATE KATONAH, NEW YORK	ZIP CODE 10536-2018

Inventor's signature


 Lee M. Nicholson

Date

23 July, 2003

FULL NAME OF INVENTOR	LAST NAME TSENG	FIRST NAME WEI-TSU	MIDDLE NAME
RESIDENCE & CITIZENSHIP	CITY HOPEWELL JUNCTION	STATE OR COUNTRY NEW YORK	CITIZENSHIP TAIWAN - REPUBLIC OF CHINA
POST OFFICE ADDRESS	P.O. ADDRESS 77 FRANCES DRIVE	CITY & STATE HOPEWELL JUNCTION, NEW YORK	ZIP CODE 12533

Inventor's signature


 Wei-Tsu Tseng

Date

July 23, 2003

FULL NAME OF INVENTOR	LAST NAME TYBERG	FIRST NAME CHRISTY	MIDDLE NAME S
RESIDENCE & CITIZENSHIP	CITY MAHOPAC	STATE OR COUNTRY NEW YORK	CITIZENSHIP US
POST OFFICE ADDRESS	P.O. ADDRESS 21 MAPLE LANE EAST	CITY & STATE MAHOPAC, NEW YORK	ZIP CODE 10541

Inventor's signature

Christy S. Tyberg

Date

_____, 2003

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Docket No. **YOR920030173US1**

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the specification of which

(check one) **XXX** is attached hereto.

_____ was filed on _____ as Application Serial No. _____ and was
amended on _____ (if applicable).

We hereby state that we have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

We acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to us to be material to the patentability of this application as defined in Title 37, Code of Federal Regulations, §1.56.

We hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate(s) listed below and have also identified below any foreign application(s) for patent or inventor's certificate(s) having a filing date before that of the application on which priority is claimed:

<u>Prior Foreign Application(s)</u>			<u>Priority Claimed</u>
_____ (Number)	_____ (Country)	_____ (Day/Mon/Year Filed)	___ Yes ___ No
_____ (Number)	_____ (Country)	_____ (Day/Mon/Year Filed)	___ Yes ___ No
_____ (Number)	_____ (Country)	_____ (Day/Mon/Year Filed)	___ Yes ___ No

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YOR920030173US1

Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

_____ (Application Serial No.)	_____ (Filing Date)	_____ (Status - patent, pend., abandon.)
_____ (Application Serial No.)	_____ (Filing Date)	_____ (Status - patent, pend., abandon.)

POWER OF ATTORNEY: As named inventors, we hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

<u>NAMES</u>	<u>REGISTRATION NUMBERS</u>
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We hereby declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

FULL NAME OF INVENTOR	LAST NAME NICHOLSON	FIRST NAME LEE	MIDDLE NAME M
RESIDENCE & CITIZENSHIP	CITY KATONAH	STATE OR COUNTRY NEW YORK	CITIZENSHIP UK
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Inventor's signature _____ Date _____, 2003
Lee M. Nicholson

FULL NAME OF INVENTOR	LAST NAME TSENG	FIRST NAME WEI-TSU	MIDDLE NAME
RESIDENCE & CITIZENSHIP	CITY HOPEWELL JUNCTION	STATE OR COUNTRY NEW YORK	CITIZENSHIP TAIWAN - REPUBLIC OF CHINA
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Wei-Tsu Tseng

FULL NAME OF INVENTOR	LAST NAME TYBERG	FIRST NAME CHRISTY	MIDDLE NAME S
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Inventor's signature  Date 7/23, 2003
Christy S. Tyberg

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Nicholson et al.
Serial No.: Not yet assigned
For: IMPROVED CHEMICAL PLANARIZATION PERFORMANCE FOR
COPPER/LOW-K INTERCONNECT STRUCTURES
Filed: Concurrently herewith
Examiner: Not yet assigned
Customer No.: 27623 Art Unit: Not yet assigned

Attorney Docket No.: YOR920030173US1

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ASSOCIATE POWER OF ATTORNEY

Commissioner for Patents
P.O. Box 1450
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Dear Sir:

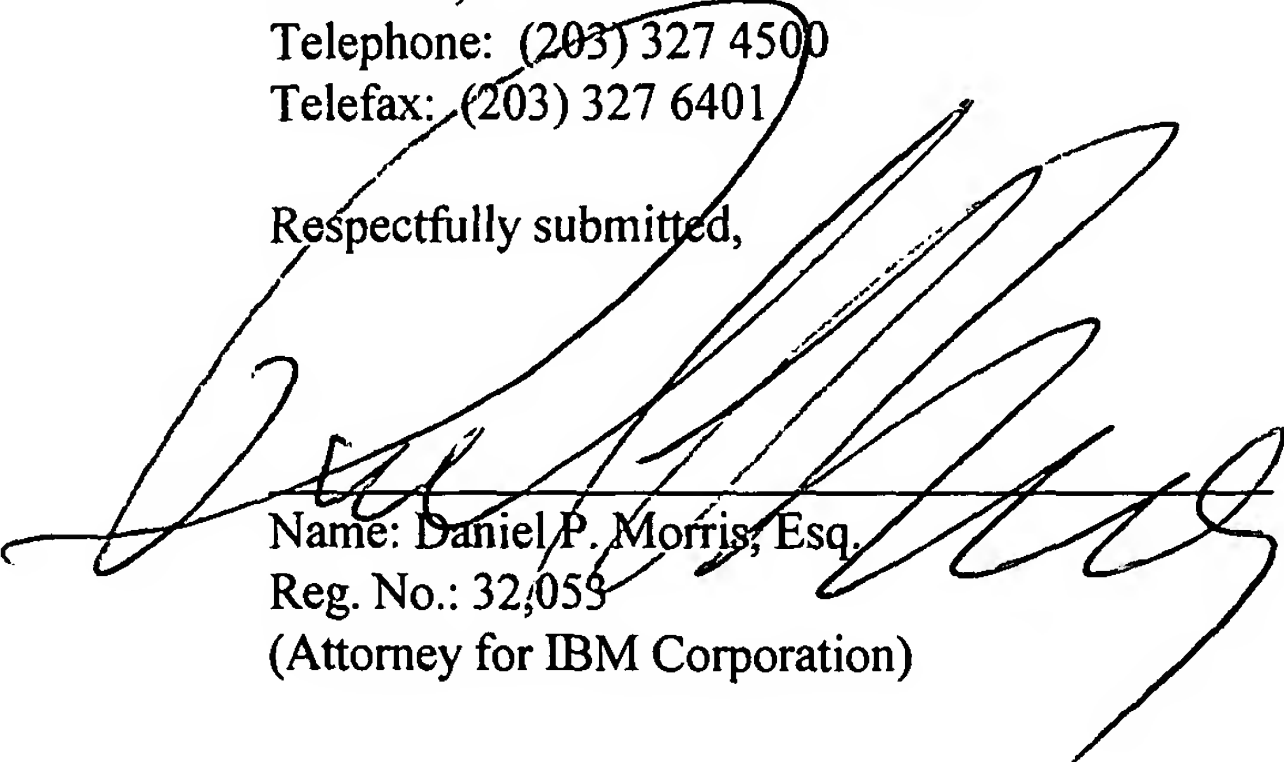
Please recognize Paul D. Greeley, Reg. No. 31,019 and Charles N. J. Ruggiero, Reg. No. 28,468 of the law firm Ohlandt, Greeley, Ruggiero & Perle, L.L.P. with offices at One Landmark Square, 10th Floor, Stamford, Connecticut 06901-2682, as an attorney, with full and complete powers to prosecute this patent application and to transact all business in the Patent and Trademark Office connected therewith.

Please continue to address all correspondence to:

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Respectfully submitted,

Date: 07/23/2003, 2003


Name: Daniel P. Morris, Esq.
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